**TA8316AS** 

**TENTATIVE** 

TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

# T A 8 3 1 6 A S

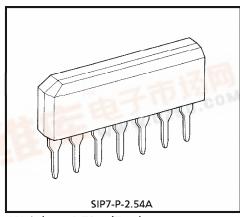
## **IGBT GATE DRIVER**

TA8316AS is a dedicated IC integrating IGBT gate drive circuits on a single chip.

A high current directly drives IGBT.

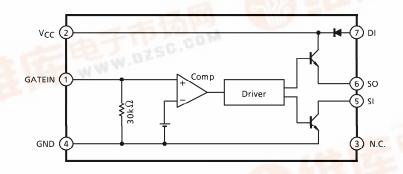
#### **FEATURES**

- Can directly control from a microcontroller
- Can directly drive the IGBT gate using a high current. Source current: -200mA (max), sink current 1A (max)
- Incorporates a diode to protect the IGBT gate at power



Weight: 0.72g (Typ.)

#### **BLOCK DIAGRAM**



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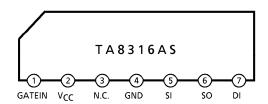
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## **PIN CONNECTION**



## **PIN FUNCTIONS**

PIN No.	PIN NAME	FUNCTION			
1	GATEIN	Gate Signal Input Pin			
2	Vcc	System Power Supply			
3	N.C.	Not Connected			
4	GND	GND			
5	SI	IGBT Gate Drive Pin 1 (Sink Side)			
6	SO	IGBT Gate Drive Pin 2 (Source Side)			
7	DI	IGBT Gate Protector Diode Pin			

## MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector Supply Voltage	Vcc	25	V
Input Voltage	V <sub>in</sub>	$GND - 0.3 \sim V_{CC} + 0.3$	V
Operating Temperature	T <sub>opr</sub>	<b>- 20∼8</b> 5	°C
Storage Temperature	T <sub>stg</sub>	<i>–</i> 55∼150	°C
Power Dissipation *	PD	925	mW

 $<sup>^{\</sup>ast}$  When Ta>25°C, PD decreases 7.4mW per degree.

# **ELECTRICAL CHARACTERISTICS** (Ta = 25°C, Unless otherwise specified, V<sub>CC</sub> = 20V)

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage Block	l						l
Operating Supply Voltage Range			_	7	_	24	V
Current Consumption 1	lCC1	_	V <sub>CC</sub> = 20V, GATEIN = "H", No Load	0.7	1.25	1.9	mA
Current Consumption 2	I <sub>CC2</sub>	_	V <sub>CC</sub> = 20V, GATEIN = "L", No Load	4.2	6.25	8.8	mA
(GATEIN Pin)							
Input Dynamic Range	V <sub>in</sub> GATEIN	_	_	0	_	V <sub>C</sub> C – 2.2	V
Threshold Voltage 1	V <sub>th</sub> GATE1	_	GATE Signal L→H	_	2.63	3	V
Threshold Voltage 2	V <sub>th</sub> GATE2	_	GATE Signal H→L	1.5	2.27	_	٧
Input Current	I <sub>in</sub> GATE	_	V <sub>in</sub> = 5V	125	167	249	μΑ
Input Frequency (Reference)	f <sub>in</sub> GATE	_	When Load C = 5600pF, R = $10k\Omega$ Connected	_	_	50	kHz
(SI Pin)						_	
"L" Level Output Voltage 1	V <sub>OL</sub> SI1	_	VGATEIN = 0V, I <sub>OL</sub> = 30mA	_	_	0.7	V
"L" Level Output Voltage 2	VOL SI2	_	VGATEIN = 0V, IOL = 1A	_	_	2	٧
"L" Level Output Voltage 3	V <sub>OL</sub> SI3	_	V <sub>CC</sub> = 7V, VGATEIN = 0V, I <sub>OL</sub> = 30mA	_	_	1	V
"L" Level Output Voltage 4 (Output Voltage At Low Supply Voltage)	V <sub>OL</sub> SI4	_	2V≦V <sub>CC</sub> <7V, VGATEIN=0V, No Load	_	_	1	V
"L" Level Output Voltage 5 (Output Voltage At Low Supply Voltage)	V <sub>OL</sub> SI5	_	$2V \le V_{CC} < 7V$ , VGATEIN = 0V, $I_{OL} = 30$ mA		_	2	V
Off Leakage Current	loff SI	_	VGATEIN = 6V, V <sub>in</sub> = 20V	<b>–</b> 1	_	1	μΑ
(SO Pin)	•	•				-	•
"H" Level Output Voltage 1	V <sub>OH</sub> SO1		VGATEIN = 6V, I <sub>OH</sub> = -30mA	V <sub>CC</sub> – 2	_	_	V
"H" Level Output Voltage 2	V <sub>OH</sub> SO2	_	VGATEIN = 6V, I <sub>OH</sub> = -200mA	V <sub>C</sub> C – 5	_	_	V
Off Leakage Current	loff SO	_	VGATEIN = 0V, V <sub>in</sub> = 0V	<b>– 1</b>	_	1	μΑ
(DI Pin)							
Input Clamp Voltage 1	V <sub>F</sub> DI1	_	l <sub>in</sub> = 500mA	_	_	V <sub>CC</sub> + 1.5	V
Input Clamp Voltage 2	V <sub>F DI2</sub>	_	V <sub>CC</sub> = 0V, I <sub>in</sub> = 300mA	_	_	V <sub>CC</sub> + 1.0	V

**TOSHIBA** 

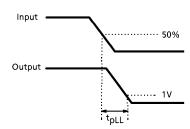
AC CHARACTERISTICS (Ta = 25°	C. Unless otherwis	e specified. $V_{CC} = 20V$ )
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CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Propagation Delay Time 1	t <sub>PLL</sub>	_	See test circuit diagram	_	_	2	$\mu$ s
Propagation Delay Time 2	<sup>t</sup> PHH	_	See test circuit diagram	_	_	2	$\mu$ s
Output Fall Time	t <sub>f</sub>	_	See test circuit	1	_	0.5	μs

## **AC CHARACTERISTICS TEST CONDITIONS**

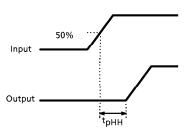
1 Propagation delay time 1 (t<sub>pLL</sub>)

Time from input of "L" level to GATEIN pin until output reaches  $1\mbox{V}$ 



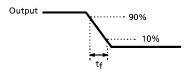
 $\ensuremath{ ext{@}}$  Propagation delay time 2 (tpHH)

Time from input of "H" level to GATEIN pin until output starts to rise

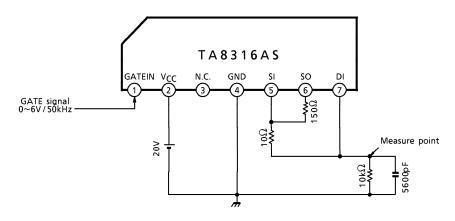


3 Output fall time (tf)

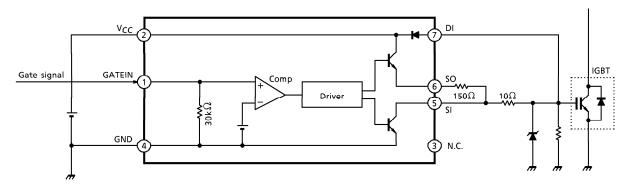
Output fall time from 90% to 10%



### DIAGRAM OF AC CHARACTERISTICS TEST CIRCUIT



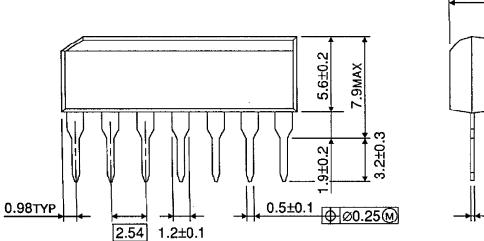
## **APPLICATION CIRCUIT**

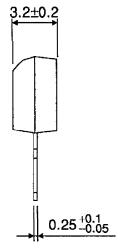


TOSHIBA TA8316AS

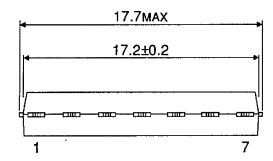
## **OUTLINE DRAWING**

SIP7-P-2.54A





Unit: mm



Weight: 0.72g (Typ.)